

Express Mail No. EL 915035164 US
PATENT

IBM/145DV1



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Mark Kenneth Hoffmeyer et al. Art Unit: Unknown
Serial No.: FILED HEREWITH Examiner: Unknown
Filed: August 8, 2001 Atty. Docket No.: IBM/145DV1
For: PROCESSING OF CIRCUIT BOARDS WITH PROTECTIVE, ADHESIVE-LESS
COVERS ON AREA ARRAY BONDING SITES

#3
11/14/01
M. P. Redger

INFORMATION DISCLOSURE STATEMENT

BOX PATENT APPLICATION
Assistant Commissioner for Patents
Washington, DC 20231

Sir:

In accordance with Applicants' duty of disclosure under the provisions of 37 C.F.R.

§ 1.56, the references listed on the enclosed Form PTO-1449 are brought to the attention of the Examiner. Each of the references was cited in the parent for the above-identified application, U.S. Serial No.09/606,583, filed on June 29, 2000. Accordingly, no copies of the references are provided.

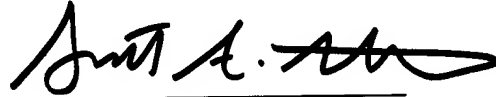
No representation is made that any of the references are "prior art" within the meaning of 35 U.S.C. § 102 or § 103. Moreover, any explanations herein are not to be taken as a representation that the references have been thoroughly reviewed. In particular, no representation as to the relative relevance of any portion of a reference is intended.

Consideration of the references and the remarks presented herein in the above-identified application is respectfully requested.

If there are any questions regarding this paper, or which might otherwise further this case onto allowance, please contact the undersigned at (513) 241-2324. Moreover, if any other charges or credits are necessary to complete this communication, please apply them to Deposit Account 23-3000.

8 AUG 2001
Date

Respectfully submitted,



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